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Blocking in Wavelength Routing Networks, Part I: The Single .. - Zhu, Rouskas, Perros (1999) (Correct) (7 citations)

parts of the network, and second, the signal **power** is channeled to the receiver and is not spread to pair in contrast, a uniform traffic **distribution** is assumed in most other studies. Second, our February 17, 1998 Abstract We study a class of **circuit**switched wavelength routing networks with and ftp.csc.ncsu.edu/pub/tech/98/TR-98-02.ps.Z

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High-Energy Physics on DECPeRLe-1 Programmable Active Memory - Moll, Vuillemin, Boucard (1995) (Correct) (5 citations)

com puting systems fall short either of computing **power**, or of I/O resources or both. 1 Introduction 1.1 features, such as tracks and energy level **distribution** in order to achieve discrimination based on using a Clibrary to describe the synchronous **circuit** to be implemented. This approach allows at the pam.devinci.fr/pub/doc/LdV/MVB95.ps.Z

Self-Timed FPGA Systems - Payne (1995) (Correct) (4 citations)

systems, due to their modularity, robustness, lowpower consumption and averagecase performance. data is passing through the system. No Clock **Distribution** Problems: Problems such as clock skew are main drawback to selftimed systems is that extra **circuitry** is required to generate the local timing www.dcs.ed.ac.uk/home/rep/selfTimedFPGA/paper.ps.gz

Hazard-Free Implementation of the Self-Timed Cell Set in a.. - Maheswaran, Akella (1994) (Correct) (1 citation)

asynchronous systems can result in minimizing **power** dissipation because only components contributing sequential **circuits**. If there exists some **distribution** of stray delays such that a **circuit** may reach to deal with them in gatelevel asynchronous **circuits** are surveyed. Then the lookup table (LUT) model ftp.ece.ucdavis.edu/pub/akella/fpga95.ps.Z

Towards Synthetic Benchmark Circuits For.. - Stroobandt.. (1999) (Correct) (1 citation)

find a solution that obeys both Rent's rule and a **power** law net degree **distribution**. Hence, for the first characteristic Rent curve and the net degree **distribution** of real versus synthetic benchmark **circuits** is Towards Synthetic Benchmark **Circuits** For Evaluating Timingdriven Cad Tools Dirk www.elis.rug.ac.be/~dstr/ISPD99.ps.Z

A Multidisciplinary Optimization Approach to Integrated.. - Lokanathan Jay (1995) (Correct) (1 citation)

the effect of spacing between cells on the **power** and delay were determined to be as shown in as input variables and compute the temperature **distribution** across the package via finite element and Network Sensitivities'IEEE Transactions on **Circuit** Theory, vol. 16, num. 3, August 1969, pp. www.cse.nd.edu/pub/Reports/1995/tr-95-5.ps.gz

Gallium Arsenide Process Evaluation Based on a RISC.. - Brown Senior (1993) (Correct) (1 citation)

means that good speed can be realized with lower **power** supply voltages, giving DCFL a good **power**delay variable width signal routing, multiphase clock **distribution**, ground planes, and automatic **power**rail sensitivity of the microprocessor and other large **circuit** blocks to different process parameters is www-personal.engin.umich.edu/~brown/.Publications/12-93.ps

Finding Improved Wire-Antenna Geometries with Genetic .. - Van Veldhuizen.. (1997) (Correct) (1 citation)

used as a good compro mise. ffl The amount of **power** used by the sensors when transmit ting a message process. Integral equations for current **distribution** on each wire are formulated, then the

for maximum **power** transfer from the antenna. Basic **circuit** design teaches the greatest amount of **power** is
www.afit.af.mil/Schools/EN/ENG/LABS/PARALLEL/Students/dvanveld/icec98.ps.gz

Architecture Evaluator's Work Bench and its Application.. - Fu, Quach, Flynn (1995) (Correct)

5 Conclusion 26 iii List of Figures 1 Area Versus **Power** Statistic for Microprocessors :

:13 11 Interconnect length **distribution** of VLSI chip in 1982 :

SPECfp92 results, and demonstrate the effect of **circuit** density on FUPA implementations. Key Words and
umunhum.stanford.edu/tr/fu/jun95.tr668.ps.Z

Experiments on Flexibilities for Logic and Routing.. - Balakrishna Kumthekar.. (Correct)

as the key determinants of overall performance and **power** dissipation-the traditional sequential design
and route tools are used. Figure 1 shows the **distribution** of all the **circuits** after place and route.

of interconnect-fail to deliver after the **circuits** are placed and routed. We use functional
bessie.colorado.edu/~kumtheka/html/papers/iwls99.ps.gz

Intrinsic Area Array ICs: What, Why, and How - Peyman Dehkordi Chandra (1997) (Correct)

of a periphery Structural/Thermal Signal Clock **Power**/Ground C4 Bumps Passivation Layer Substrate Pads
metal lay er of the die or on an additional **distribution** metal layer. The purpose of this paper is to
approach, it is possible to design chips around **circuit** constraints rather than pad constraints that
microsys6.engr.utk.edu/ece/mcmc97_2.ps

Development of a DSP/MCM Subsystem Assessing Low-volume.. - Peyman Dehkordi Tim (1996) (Correct)

selected is a 37 mm x 37 mm 5layer (1 pad, 2 **power**, and 2 routing layers, 62 pitch) MCMD based
including all branches was 77.286 mm. The delay **distribution** on the module is shown in below: percent paths
noise, rise/fall times, and coupling noises on **circuit** networks of arbitrary topology. A typical
microsys6.engr.utk.edu/ece/mcmc96_2.ps

An Accurate and Stochastic-Based Approach to Timing-Driven.. - Dutt (Correct)

of choice for optimizing any objective like timing, **power** and area. We establish desirable characteristics
incorporating design constraints (e.g. uniform **distribution** of wiring across routing channels)and
to deep submicron technology, and to the large **circuits** that are implemented on such chips. We present
www.eecs.uic.edu/~dutt/.papers/ispd98-2.ps

Minimizing the Effect of Clock Skew Via Circuit Retiming - Brian Lockyear (1993) (Correct)

Minimizing the Effect of Clock Skew Via **Circuit** Retiming Brian Lockyea
ftp.cs.washington.edu/tr/1993/05/UW-CSE-93-05-04.PS.Z

Combinatorial Aspects of Lower Power Clock Layout Synthesis in.. - Jun Dong (Correct)

Combinatorial Aspects of Lower **Power** Clock Layout Synthesis in VLSI Synchronous
load and switching at high fre quency, clock **distribution** is a major source of **power** dissipation. Also,
Power Clock Layout Synthesis in VLSI Synchronous **Circuits** Jun Dong Cho Dept. of Electrical and Computer
vada.skku.ac.kr/Project/published/clock_lp.ps

Clock-Routing Driven Layout Methodology for Semi-Synchronous .. - Atsushi Takahashi (Correct)

network C may de pend on the wiring area, **power** consumption, and relia bility. But it has
expensive part in modern VLSIs is the clock **distribution** network where the clock is assumed to be
Driven Layout Methodology for SemiSynchronous **Circuit** Design 3 Atsushi TAKAHASHI, Wataru TAKAHASHI,
ku-www.ss.titech.ac.jp/~atushi/place-tau.ps

Implications Of Area-Array I/o For Row-Based Placement.. - Caldwell Kahng (Correct)

[15]Peripheral I/O pads also constrain clock/**power distribution**, and their in herently large
Peripheral I/O pads also constrain clock/**power distribution**, and their in herently large parasitics cause
May Be Correlated With Topological Depth Of **Circuits**. 1. Introduction Ic Packaging Technologies With
nexus6.cs.ucla.edu/~abk/papers/conference/c74.ps

Resume - Shao (Correct)

distribution system design'IEEE Transactions on **Power** Delivery, Vol. 6, No. 4, pp. 16071615, October
and Y. Zhang, An expert system for secondary **distribution** system design'IEEE Transactions on **Power**
Numerical Computation, Electromagnetic The ory, **Circuits** and Systems, Electronics Lab, and

www.isr.umd.edu/~jshao/resume/resume.ps

Learning As Applied to Simulated Annealing - Lixin Su (Correct)

or handle a variety of tradeoffs between area, **power**, and timing, for example. Design technologists of generating a move is referred to as proposal **distribution**[5]The computation of p, r, and their by learning from the annealing of benchmark **circuits**. This model is then used in the trained www-cad.eecs.berkeley.edu/~lixinsu/research/paper1.ps

On Ultrametricity in Feedforward Neural Network Error Surfaces - Gallagher, Downs (Correct)

of the nature of the error surface will enable more **powerful** training algorithms to be developed, and more points were then used to generate the sample **distributions** described in the previous section. Three problems (e.g, traveling salesman [4]**circuit placement** [8] and graph colouring [2]1)and www.elec.uq.edu.au/~annis/papers/gallagher_acnn98.ps.gz

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frequencies, structure, 7 speed ultimate The gain. **power** the and current the both for Ghz 40 were the is Charge tails those participate, function **distribution** hotcarrier the of tails highenergy the in the structure, CHINT basic the in Thus, elements. **circuit** novel of implementation the allows have we www.ee.sunysb.edu/~serge/101.ps.gz

[Energy Consumption Management in Design - Smit](#) (Correct)

Abstract-A survey of the basic issues in low **power** design is presented, including techniques for is usually a signal with a random sig nal **distribution**. So the statistics of the remainder are better in the early design phase of analog and digital **circuits**. The concept of energy complexity will be www.stw.nl/programmas/prorisc/workshop/proc/psz/smit1.ps.gz

[Standard Cell Placement For Even On-Chip Thermal Distribution - Ching-Han Tsai](#) (Correct)

dif ferential constraint to its corresponding **power distribution** constraint. Dealing directly with Standard Cell **Placement** For Even Onchip Thermal **Distribution** Chinghan Tsai Sungmo (steve) Kang uivlsi.csl.uiuc.edu/~chtsai/Personal/./Publications/ispd99.ps.gz

[Alewife Systems Memo 24 - Implementation Of](#) (Correct):6 2.4 **Power distribution** :

Alewife machine using one Alewife node per printed **circuit** board. Alewife nodes are processing elements pattern or folded up in card cages. The logical **placement** of the connectors on the board using a mosaic ftp.cag.lcs.mit.edu/alewife-memos/24.ps.Z

[Constructive Algorithms Based on Graph Minors - Govindan, Langston.. \(1997\)](#) (Correct)

advances in the field of graph minors have yielded **powerful** nonconstructive tools to tackle many finding a threetrack gate matrix layout for VLSI **circuits**. We design a streamlined test for a half dozen rows and columns to provide transistor **placement** and interconnections. The columns are realized www.cs.utk.edu/~library/TechReports/1997/ut-cs-97-345.ps.Z

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Industrial Electronics, Control, Instrumentation, and Automation, 1992. 'Power Electronics and Motion Control', Proceedings of the 1992 International Conference on , 9-13 Nov. 1992

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Kiamilev, F.E.; Krishnamoorthy, A.V.; Rozier, R.G.; Rieve, J.; Aplin, G.F.; Hull, C.D.; Farbarik, R.; Oettel, R.E.;
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Krishnamoorthy, A.; Oettel, R.;
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Teng, S.Y.; Lee, T.-Y.T.;

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